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(54) **METHODS AND CIRCUITS FOR ASYMMETRIC DISTRIBUTION OF CHANNEL EQUALIZATION BETWEEN DEVICES**

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H03H 7/30 (2006.01)

(52) **U.S. Cl.**
USPC **375/233**; 375/219

(58) **Field of Classification Search**
USPC 375/233, 321, 219, 222, 211, 220, 375/221
See application file for complete search history.

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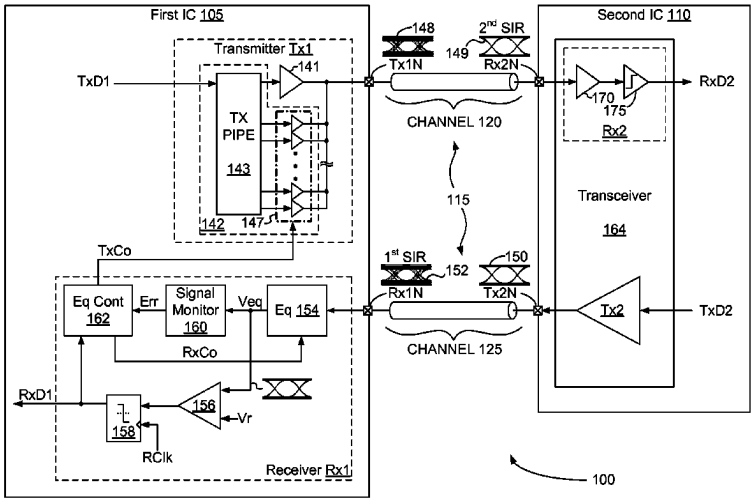
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(57) **ABSTRACT**

A transceiver architecture supports high-speed communication over a signal lane that extends between a high-performance integrated circuit (IC) and one or more relatively low-performance ICs employing less sophisticated transmitters and receivers. The architecture compensates for performance asymmetry between ICs communicating over a bidirectional lane by instantiating relatively complex transmit and receive equalization circuitry on the higher-performance side of the lane. Both the transmit and receive equalization filter coefficients in the higher-performance IC may be adaptively updated based upon the signal response at the receiver of the higher-performance IC.

31 Claims, 9 Drawing Sheets



Volex Exhibit 1012
Volex v. Credo

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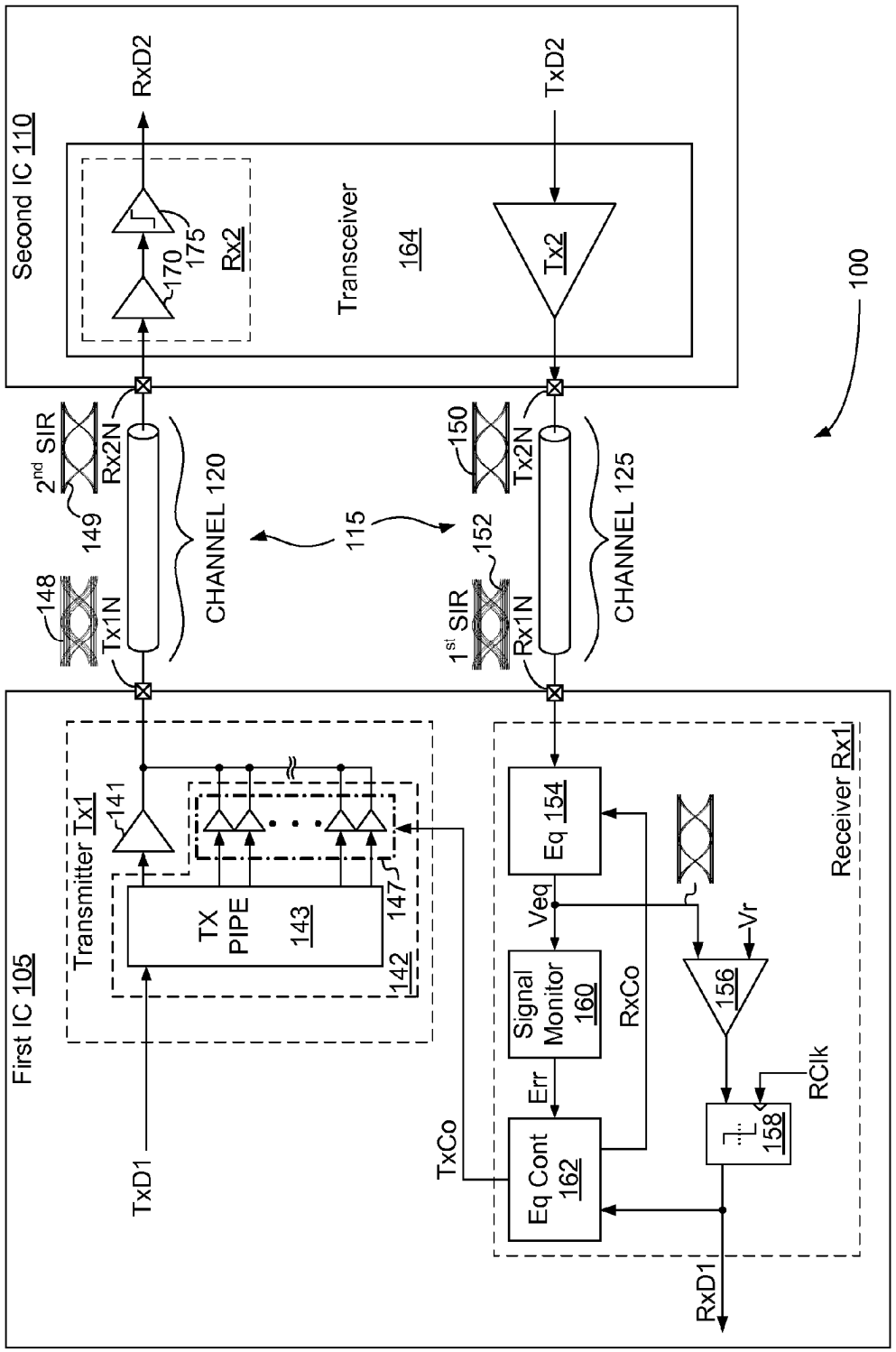

Second IC 110
RxD2
TxD2
Transceiver
164
Rx2
175
170
Tx2
100
2nd SIR
Rx2N
149
CHANNEL 120
115
150
Tx2N
CHANNEL 125
148
Tx1N
152
1st SIR
Rx1N
First IC 105
Transmitter Tx1
141
TX PIPE
143
147
142
TxD1
TxCo
Eq 154
Veq
Signal Monitor 160
RxCo
Err
Eq Cont 162
Vr
156
RClk
158
Receiver Rx1
RxD1

FIG. 1

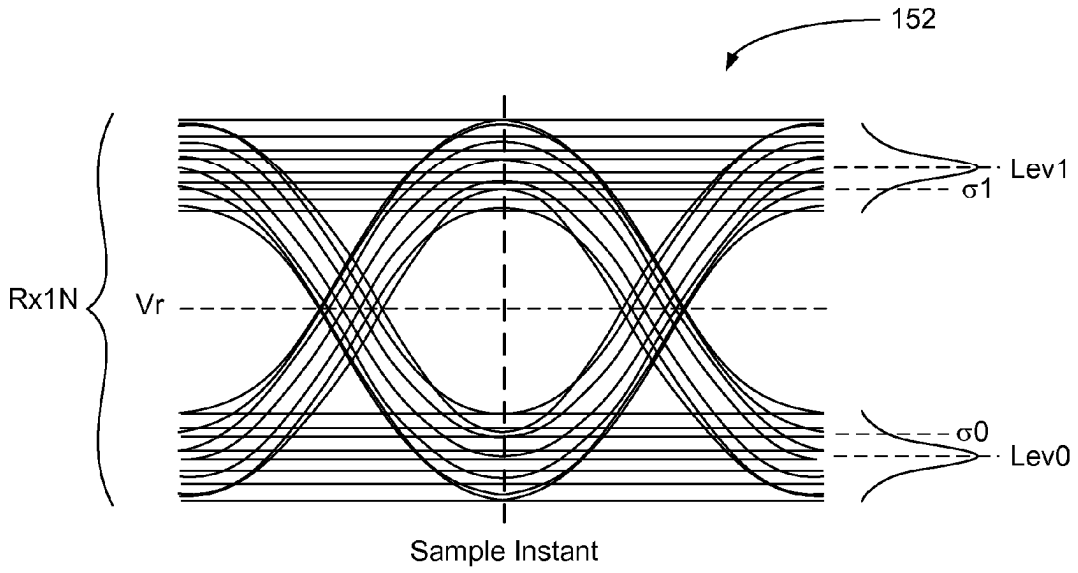

152
Lev1
σ1
Rx1N
Vr
σ0
Lev0
Sample Instant

FIG. 2A

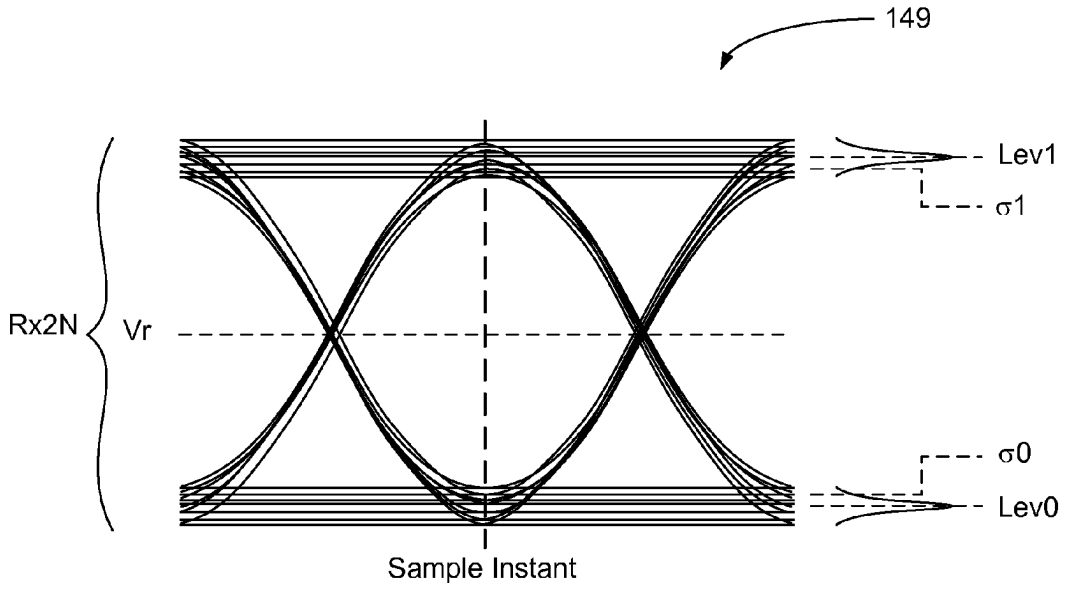

149
Lev1
σ1
Rx2N
Vr
σ0
Lev0
Sample Instant

FIG. 2B

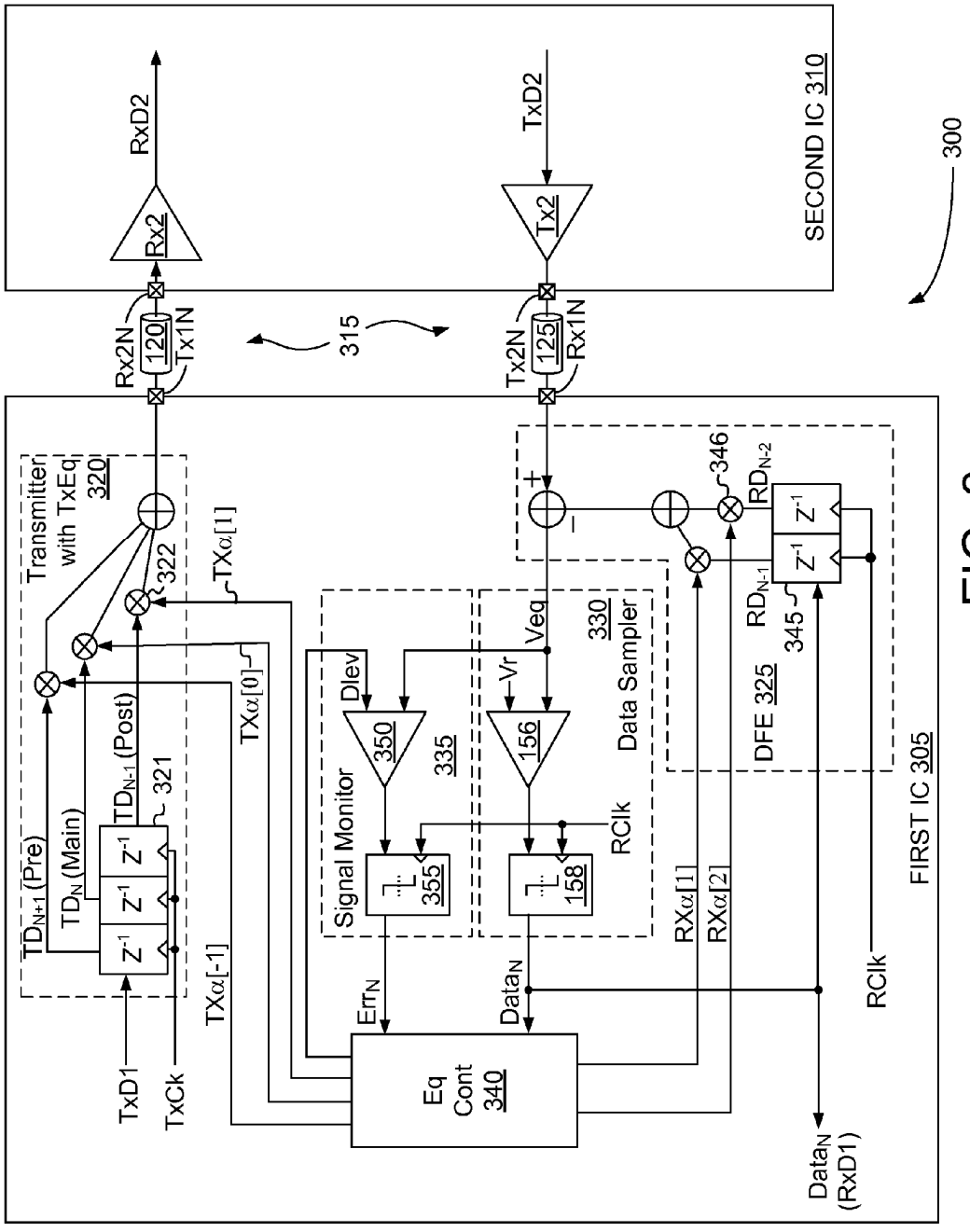

SECOND IC 310
300
RxD2
Rx2
TxD2
Tx2
Rx2N
120
Tx1N
315
Tx2N
125
Rx1N
FIRST IC 305
Transmitter with TxEq
320
322
TXα[1]
TXα[0]
TXα[-1]
TD_{N+1} (Pre)
TD_N (Main)
TD_{N-1} (Post)
321
Z^-1
TxD1
TxCk
Signal Monitor
Dlev
350
335
355
Err_N
Veq
Vr
156
158
Data Sampler
330
RClk
Data_N
Eq Cont 340
DFE 325
346
RD_{N-2}
RD_{N-1}
345
RXα[1]
RXα[2]
Data_N (RxD1)

FIG. 3

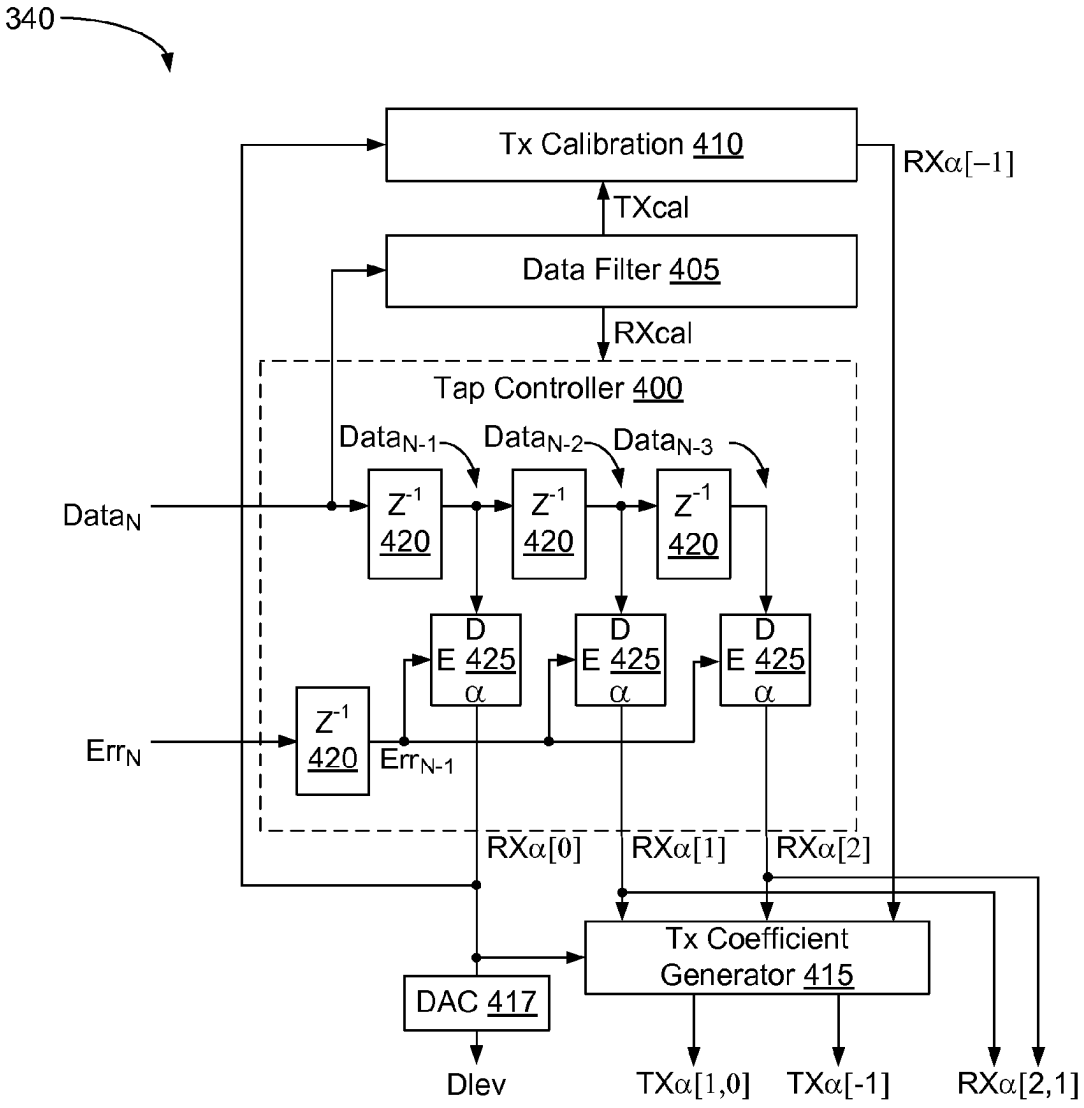

340
Tx Calibration 410
RXα[−1]
TXcal
Data Filter 405
RXcal
Tap Controller 400
Data$_{N-1}$
Data$_{N-2}$
Data$_{N-3}$
Data$_N$
Z^{-1} 420
Z^{-1} 420
Z^{-1} 420
D E 425 α
D E 425 α
D E 425 α
Err$_N$
Z^{-1} 420
Err$_{N-1}$
RXα[0]
RXα[1]
RXα[2]
Tx Coefficient Generator 415
DAC 417
Dlev
TXα[1,0]
TXα[-1]
RXα[2,1]

FIG. 4A

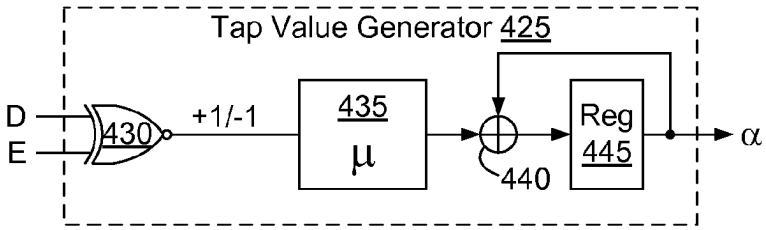

Tap Value Generator 425
D
E
430
+1/-1
435
μ
440
Reg 445
α

FIG. 4B

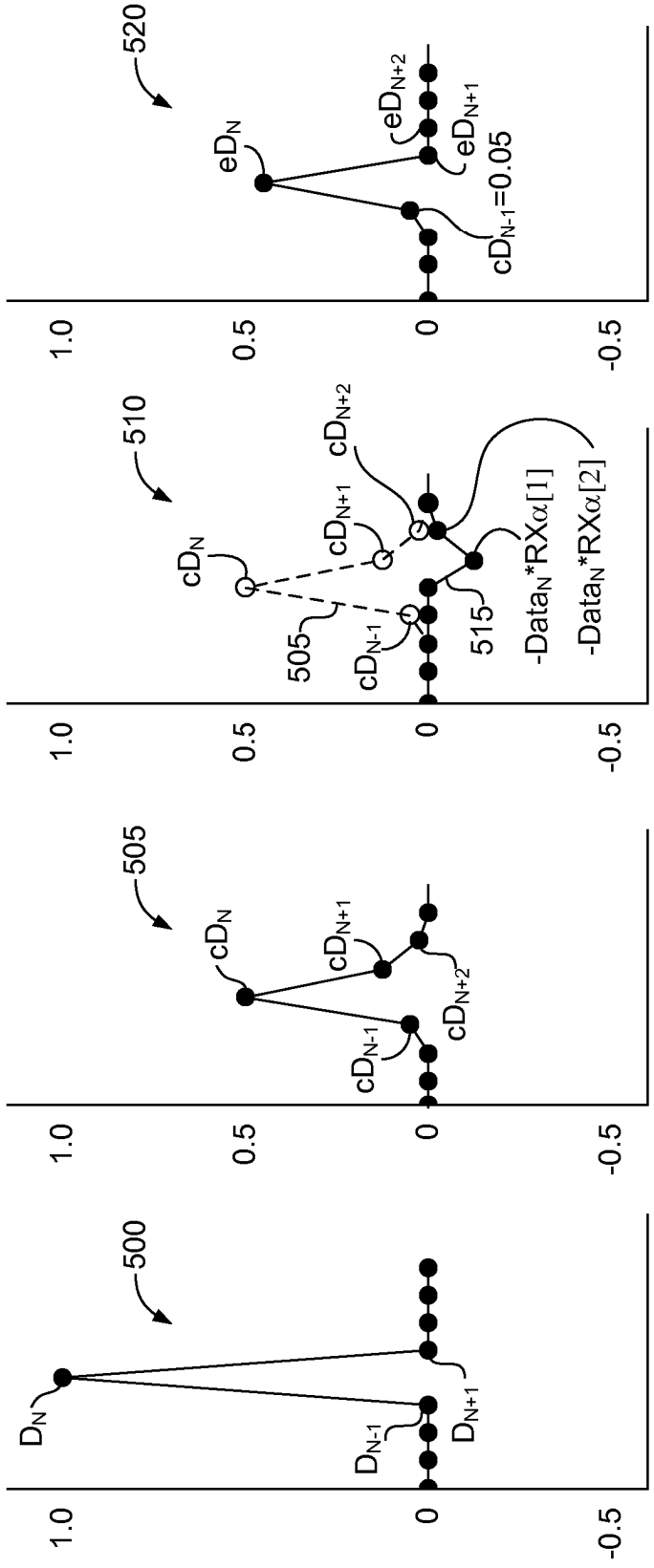


FIG. 5A FIG. 5B FIG. 5C FIG. 5D

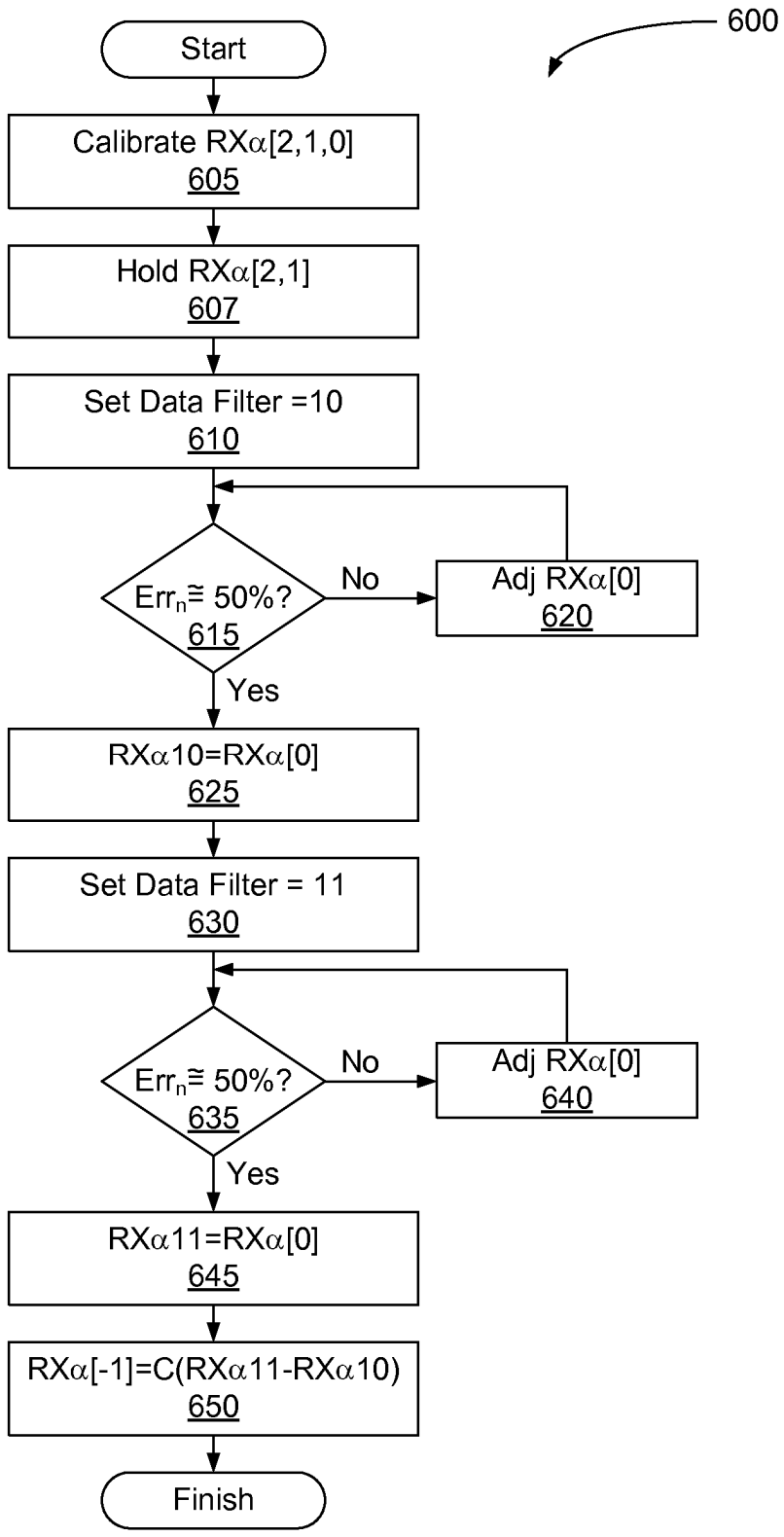

600
Start
Calibrate RXα[2,1,0]
605
Hold RXα[2,1]
607
Set Data Filter =10
610
Err_n≅ 50%?
615
No
Adj RXα[0]
620
Yes
RXα10=RXα[0]
625
Set Data Filter = 11
630
Err_n≅ 50%?
635
No
Adj RXα[0]
640
Yes
RXα11=RXα[0]
645
RXα[-1]=C(RXα11-RXα10)
650
Finish

FIG. 6

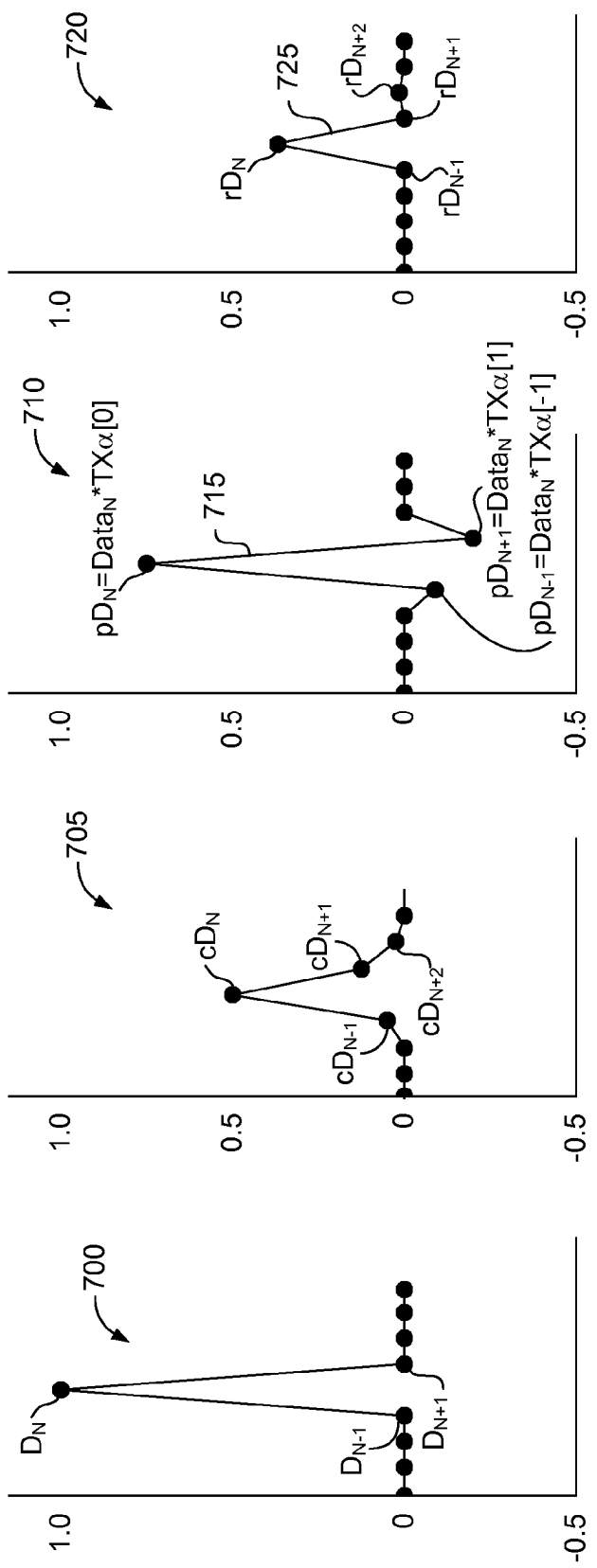


FIG. 7A FIG. 7B FIG. 7C FIG. 7D

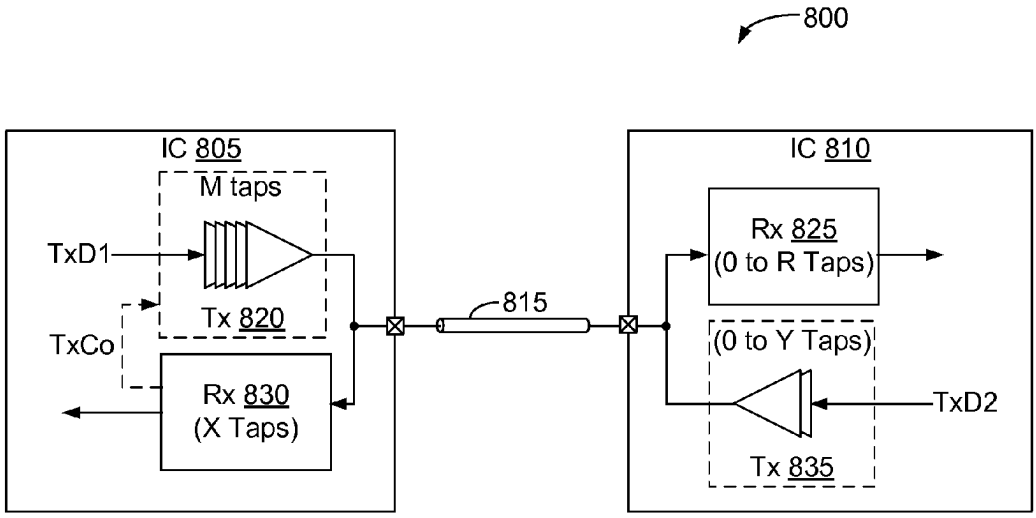

800
IC 805
M taps
TxD1
Tx 820
TxCo
Rx 830
(X Taps)
815
IC 810
Rx 825
(0 to R Taps)
(0 to Y Taps)
TxD2
Tx 835

FIG. 8

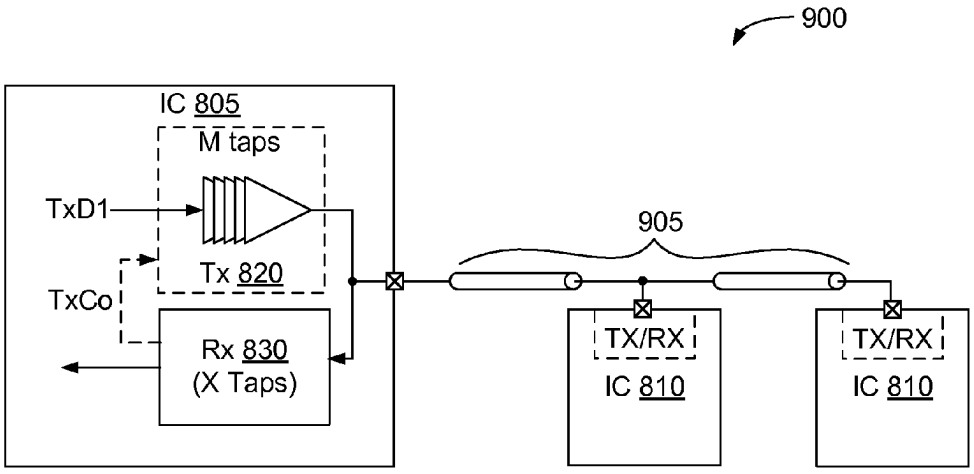

900
IC 805
M taps
TxD1
Tx 820
TxCo
Rx 830
(X Taps)
905
TX/RX
IC 810
TX/RX
IC 810

FIG. 9

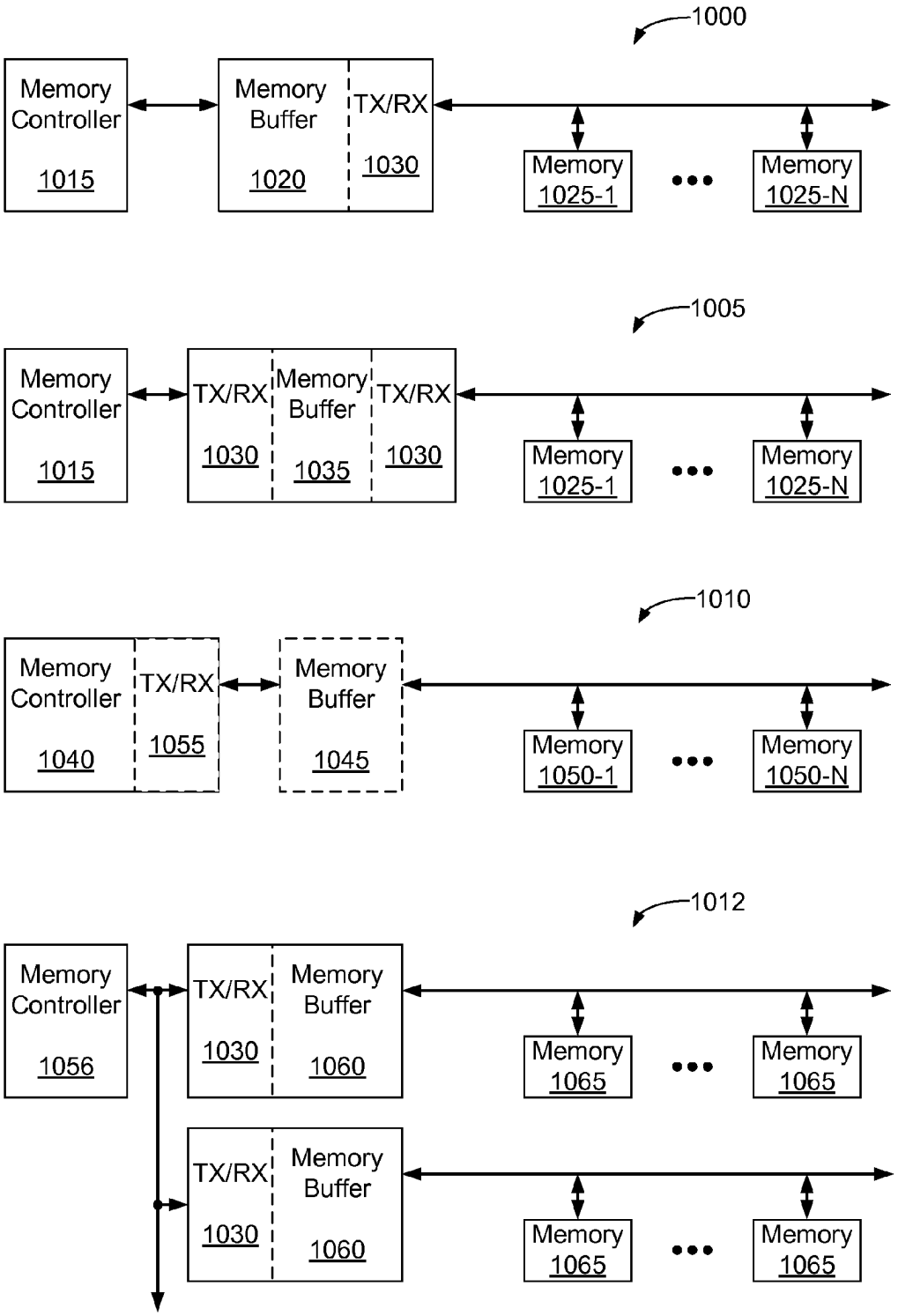

1000
Memory Controller 1015
Memory Buffer 1020
TX/RX 1030
Memory 1025-1
Memory 1025-N
1005
Memory Controller 1015
TX/RX 1030
Memory Buffer 1035
TX/RX 1030
Memory 1025-1
Memory 1025-N
1010
Memory Controller 1040
TX/RX 1055
Memory Buffer 1045
Memory 1050-1
Memory 1050-N
1012
Memory Controller 1056
TX/RX 1030
Memory Buffer 1060
Memory 1065
Memory 1065
TX/RX 1030
Memory Buffer 1060
Memory 1065
Memory 1065

FIG. 10

METHODS AND CIRCUITS FOR ASYMMETRIC DISTRIBUTION OF CHANNEL EQUALIZATION BETWEEN DEVICES

FIELD OF THE INVENTION

The present invention relates generally to the field of communications, and more particularly to high speed electronic signaling within and between integrated circuit devices.

BACKGROUND

The performance of many digital systems is limited by the interconnection bandwidth within and between integrated circuit devices (ICs). High performance communication channels between ICs suffer from many effects that degrade signals. Primary among them are frequency dependent channel loss (dispersion) and reflections from impedance discontinuities, both of which lead to inter-symbol interference (ISI). Attempts to address these effects have employed various equalization schemes at the transmitter and receiver. Ideally, transmit and receive equalization work together to mitigate the degradation imposed by the channel, and thus allow increased data rates and/or reduced probability of communication errors.

In some systems, memory systems for example, the communicating ICs have an asymmetry to them that complicates optimization of the transmit and receive equalization schemes applied to counter the effects of the corresponding channel. For example, a memory controller that communicates with one or more memory devices may benefit from a fabrication technology that is different from that best suited for manufacturing the memory devices. It is therefore often the case that a memory controller can employ circuitry that exhibits significantly higher performance in speed and power than that of the associated memory device or devices. This process performance asymmetry between the communicating ICs complicates the task of optimizing equalization between the two types of devices.

BRIEF DESCRIPTION OF THE DRAWINGS

The subject matter disclosed is illustrated by way of example, and not by way of limitation, in the figures of the accompanying drawings and in which like reference numerals refer to similar elements and in which:

FIG. **1** illustrates an asymmetrical signaling system **100** in accordance with one embodiment.

FIGS. **2**A and **2**B depict hypothetical waveforms illustrative of signals **152** and **149** on respective receiver pads Rx**1**N and Rx**2**N.

FIG. **3** depicts a high-speed communication system **300** in accordance with another embodiment.

FIG. **4**A depicts equalization control circuitry **340** in accordance with one embodiment.

FIG. **4**B details an embodiment of a tap-value generator **425** of FIG. **4**A that generates a tap value using a sign-sign, least-mean-squared (LMS) algorithm.

FIGS. **5**A through **5**D are hypothetical waveform diagrams used in connection with FIGS. **3** and **4**A to illustrate the process of applying appropriate receive coefficients RXα[2:1] to DFE **325** to correct for ISI introduced over channel **125**.

FIG. **6** is a flowchart **600** outlining a process by which calibration block **410** may calculate pre-cursor transmit coefficient TXα[−1].

FIGS. **7**A through **7**D are hypothetical waveform diagrams used to illustrate the effects of applying the above-derived transmit coefficients to signals on transmit channel **120**.

FIG. **8** depicts an asymmetrical signaling system **800** in accordance with another embodiment.

FIG. **9** depicts an asymmetrical signaling system **900** in accordance with yet another embodiment.

FIG. **10** depicts three memory topologies **1000**, **1005**, and **1010** that incorporate asymmetrical signaling systems in accordance with various embodiments.

DETAILED DESCRIPTION

FIG. **1** illustrates an asymmetrical signaling system **100** in accordance with one embodiment. System **100** includes a first integrated circuit (IC) device **105** coupled to a second IC device **110** via a high-speed signal lane **115**. In this example, lane **115** includes a transmit channel **120** and a receive channel **125**, which may comprise circuit-board traces. The transmit and receive channels may be implemented over the same conductor or set of conductors in other embodiments. Device **105** may be fabricated using a process that affords considerably higher transmit and receive circuit density and speed performance than the process employed in fabricating device **110**. In one embodiment, for example, the minimum feature size for input/output transistors on device **105** is less than 50% of the minimum feature size for input/output transistors on device **110**. In other embodiments, device **105** has at least twice the number of interconnect layers as device **110**, allowing more compact implementation of complex circuits. Communication system **100** accommodates the resulting performance asymmetry between devices **105** and **110** by instantiating the majority of the complex equalization circuitry on device **105**. Transmit and receive channels **120** and **125** can thus support the same relatively high symbol rate without burdening the second device **110** with the area and power required to support complex equalization circuits.

Performance asymmetry between communicating devices might be desirable for reasons other than or in addition to process differences. For example, market demands may weigh more heavily on one of a pair of communicating devices, making it economically advantageous to minimize the complexity of that device. Also, total system cost can be reduced where the performance-enhanced circuitry can be instantiated on one or a relative few devices that communicate with a greater number of less sophisticated devices.

Device **105** includes a transmitter Tx**1** that transmits data received from an internal transmit-data input node TxD**1** over channel **120** via a first transmitter pad Tx**1**N, and further includes a receiver Rx**1** that receives data from channel **125** via a first receiver pad Rx**1**N. Device **110** includes a second transmitter Tx**2** that transmits data to receiver Rx**1** via a second transmitter pad Tx**2**N, channel **125**, and first receiver pad Rx**1**N. Device **110** further includes a second receiver RX**2** that receives the data transmitted from transmitter Tx**1** via first transmitter pad Tx**1**N, channel **120**, and a second receiver pad Rx**2**N.

Transmitter Tx**1** includes an output driver **141** and a multi-tap transmit equalizer **142**. Transmit equalizer **142** is composed of a transmit pipe **143** and an array of one or more output drivers or sub-drivers **147** in the depicted embodiment. Output driver **141** and sub-drivers **147** function collectively to drive an equalized version of a transmit data signal TxD**1** onto transmitter pad Tx**1**N, which may be a bond pad of device **105**. The particular transmit equalizer in this embodiment may also be referred to as a finite-impulse-response (FIR) equalizer. Equalizers on the transmit-side of a communica-

tion channel are sometimes referred to as "pre-emphasis equalizers" or "de-emphasis equalizers" because they emphasize or de-emphasize signal components prior to transmission over the channel in order to mitigate the degrading effects of the channel. For example, transmit equalization, typically a flattening of the total amplitude response over a frequency band of interest, can be accomplished by amplifying (emphasizing) the signal frequency components most sensitive to channel loss, by attenuating (deemphasizing) signal components that are less sensitive to channel loss, or by a combination of the two. The goal of equalization is typically to reduce or minimize the effects of ISI observed at the receive side of the channel (e.g. at pad or pads Rx**2**N). Equalization is typically accomplished by adjusting a characteristic of a signal in order to mitigate the effects of ISI.

Channels **120** and **125** are assumed to act as simple low-pass filters in this example. For each transmitted symbol, equalization signals from sub-drivers **147** combine with the main signal from driver **141** to selectively deemphasize low-frequency signal components relative to high-frequency signal components, and thus to compensate in advance for the low-pass nature of channel **120**. Transmitter Tx**1** therefore transmits a signal **148** with a relatively low signal-to-ISI ratio (SIR) on node Tx**1**N. Channel **120** filters out much of the ISI, and the resulting propagated signal arrives at node Rx**2**N of receiver Rx**2** as a relatively high SIR waveform, signal **149**. The transmit signal Tx**1**N conveyed over channel **120** may be a binary, differential, AC-coupled voltage signal. Other embodiments may employ signals that are e.g. single-ended, multilevel, DC coupled, or current driven. Moreover, the frequency response of a given channel may differ considerably from a simple low-pass filter. Many variations will be evident to those skilled in the art.

Each of sub-drivers **147** is either a pre-tap sub-driver or post-tap sub-driver. If driver **141** has already transmitted the symbol value at the input to a given sub-driver, that sub-driver is a post-tap sub-driver; if driver **141** has yet to transmit the symbol value at the input to the sub-driver, that sub-driver is a pre-tap driver. Transmit pipe **143** might select, for example, N post-tap drivers and one pre-tap driver; accordingly, the signal at transmitter pad Tx**1**N would have a signal level according to data values having symbol latencies of −1, 0, 1, 2, . . . , N, where the symbol latency of a given data value refers to the number of symbol times by which the data value of the sub-driver lags that through the main driver **141**. In an alternate embodiment the entire driver can be realized as a high-speed digital-to-analog converter (DAC) structure which can drive arbitrarily complex waveforms (to the DAC resolution), and the pre-emphasis may be computed in the digital domain on signals that are provided to the DAC inputs.

Different numbers of post-tap and pre-tap drivers may be provided in alternative embodiments, thereby allowing for transmit equalization based on values having different symbol latencies with respect to the main tap. The respective tap weights of sub-drivers **147** can be controlled by application of transmit coefficients TxCo to a corresponding port. Each of the transmit coefficients may be adjusted over a range of values to tailor transmitter Tx**1** to a particular channel and noise environment. Such adjustments can be applied once, e.g. at power-up, or can be adapted periodically during system operation to account for changes in the system environment that may impact performance. Methods and circuits for setting transmit coefficients in accordance with some embodiments are discussed below.

Transmitter Tx**2** transmits a signal **150** having a relatively high SIR at node Tx**2**N as can be observed by the relatively clean opening of the eye diagram. Channel **125** induces ISI and loss that degrades signal **150**, and thus presents a signal **152** having a relatively low SIR on node Rx**1**N. An equalizer **154** within receiver Rx**1** equalizes signal **152** to compensate for the channel ISI, and thus produces an equalized signal Veq. Continuous-time equalizers, decision-feedback equalizers (DFE), and partial response DFE equalizers, among others, are types of equalizers known to those skilled in the art that may be used for equalizer **154**. A differential amplifier **156** compares equalized signal Veq with a reference voltage Vr, and a sampler **158** periodically samples the output of amplifier **156** to recover the data RxD**1** expressed in signal TxD**2** from transmitter Tx**2**.

Receiver Rx**1** additionally includes a signal monitor **160** and equalization control circuitry **162**. Signal monitor **160** provides an error signal Err that can be used as a measure of the signal ISI remaining on equalized signal Veq. Equalization control circuitry **162** employs error signal Err and in some embodiments the recovered data RxD**1** to adjust receive coefficients RxCo that control equalizer **154** to minimize the ISI on equalized signal Veq.

Control circuitry **162** further adjusts transmit coefficients TxCo to transmitter Tx**1** to minimize the ISI on signal **149**, which is at the far end of channel **120**. In other words, control circuitry **162** adjusts transmit equalizer **142** such that the waveform conditioning induced on signal **148** closely compensates for the undesired ISI imposed by channel **120**, and therefore minimizes the impact of channel-induced ISI at node Rx**2**N of device **110** based on the behavior of the receive equalizer in Receiver Rx**1**.

Transmit coefficients TxCo may be generated based upon the characteristics of transmit channel **120**. In some such embodiments, a signal monitor on receiver Rx**2** and a back-channel communication link may be used to communicate error signal measurement information from device **110** to **105**. In the depicted embodiment, control circuitry **162** instead derives transmit coefficients TxCo from the characteristics of receive channel **125**. Such derivations may be used where the transmit and receive channels exhibit similar characteristics: e.g. frequency-dependent attenuation, dispersions, and/or reflections. Such assumptions are particularly valid when channels **120** and **125** are the same channel and transmission is bi-directional, or when channels **120** and **125** are portions of a parallel bus between device **105** and device **110**. Deriving transmit coefficients from receive-channel characteristics reduces or eliminates the need for evaluating signal quality at receiver Rx**2**, which in turn reduces the requisite complexity of second IC device **110**.

Turning now to second IC device **110**, receiver Rx**2** and transmitter Tx**2** are each part of a transceiver **164** that conveys data to and from some core logic (not shown), such as one or more blocks of dynamic random-access memory cells. Receiver Rx**2** may be simple relative to receiver Rx**1**, and here includes a preamplifier **170** and a sampler **175**. Preamplifier **170** may support data threshold-voltage adjustments and sampler **175** may support timing adjustments, in which case the sample voltage and timing of receiver Rx**2** may be centered within received data eyes at the input of sampler **175**. Though not shown, receiver Rx**2** can additionally include some simple receive-equalization circuitry, though this can be less complex—and consequently less expensive and area-intensive—than the circuitry of receiver Rx**1**. Transmitter Tx**2** can likewise provide some transmit equalization, but the circuitry employed for this purpose can be less complex than the circuitry transmitter Tx**1** employs for this purpose. For example, transmitter Tx**2** can have fewer filter taps than transmitter Tx**1**, or have fixed tap settings that are known to provide a minimal baseline of equalization.

FIGS. **2**A and **2**B depict hypothetical waveforms illustrative of signals **152** and **149** on respective receiver pads Rx**1**N and Rx**2**N. Each waveform includes a respective signal eye that exhibits a signal-to-interference ratio (SIR) at the sample instant. Given that there are a number of ways to measure the SIR of a signal, the present disclosure refers to the particular measure of interest here as the "eye SIR," or just SIR. Each reference to an SIR pertains to this particular measure.

In FIG. **2**A, the voltage levels labeled Lev**1** and Lev**0** represent the average levels representing logic ones and logic zeros, respectively. The standard deviations of the voltage levels in cases where a logic one or a logic zero is received are denoted by σ**1** and σ**0**, respectively. The separation between Lev**1** and receiver threshold Vr is the amount of received "signal" for a logic one, and the ratio between this amount and σ**1** may be used to compare the signal and interference levels when a logic one is received. Similarly, the ratio of the separation between Lev**0** and Vr to σ**0** may be used when a logic zero is received. The lower of these two ratios is usually a critical factor in the bit error rate of the receiver. Therefore, we define the SIR in equation form:

$$SIR=\mathrm{Min}(|Lev1-Vr|/\sigma 1,|Lev0-Vr|/\sigma 0) \quad \text{Eq. 1}$$

Transmitter Tx**2** is relatively unsophisticated, so the signal at node Rx**1**N exhibits considerable noise (e.g. ISI) as a result of the dispersion and reflections of channel **125**. As shown, signal **152** at receiver pad Rx**1**N exhibits a relatively low SIR. In contrast, the relatively sophisticated equalizer of transmitter Tx**1** compensates for the attenuation of write channel **120** in advance of transmission. The resulting signal **149** at receiver pad Rx**2**N therefore exhibits a relatively high SIR as compared with that of signal **152**. In one embodiment, the SIR at receiver pad Rx**2**N is at least 30% higher than the SIR at receiver pad Rx**1**N. Other embodiments may adapt equalizers for similar objectives, such as maximizing the signal-to-noise difference (vertical eye opening) instead of the signal-to-noise ratio, maximizing the horizontal eye opening relative to jitter, or minimizing the overall bit-error rate (BER) of the channel.

The symbol rates of signals conveyed over channels **120** and **125** may be maintained substantially equal despite the performance asymmetry between devices **105** and **110**. The sophisticated equalization employed by transmitter Tx**1** allows for a high-quality (high SIR) signal at node Rx**2**N, and thus facilitates use of a relatively simple receiver Rx**2**, and the sophisticated equalization employed by receiver Rx**1** allows receiver Rx**1** to correctly interpret low-quality (low SIR) signals, and thus facilitates use of a relatively simple transmitter Tx**2**.

FIG. **3** depicts a high-speed communication system **300** in accordance with another embodiment. System **300** includes first and second IC devices **305** and **310** separated by a signal lane **315**. The embodiment of FIG. **3** is in some ways like system **100** of FIG. **1**, like-numbered elements being the same or similar.

First device **305** includes a transmitter **320** that supports transmit equalization, e.g. of the type discussed above in connection with FIG. **1**. Device **305** additionally includes a receive equalizer **325**, a data sampler **330**, a signal monitor **335**, and equalization control circuitry **340**. Second device **310** is similar to second device **110** of FIG. **1**: a detailed discussion of device **310** is therefore omitted for brevity.

Transmitter **320** includes a three-tap transmit equalizer, which in turn includes a FIFO buffer **321** and three coefficient multipliers **322**. The transmit equalizer is a finite impulse response (FIR) equalizer in this example, though other types of equalizers may be used instead of or in addition to an FIR. Buffer **321** presents pre-tap data TD_{N+1}, current (main) data TD_N, and post-tap data TD_{N-1} to respective coefficient multipliers **322**. Multipliers **322** multiply the outputs of buffer **321** by respective tap coefficients TXα[1, 0, −1], and the sum of the outputs of multipliers **322** is presented on pad or pads Tx**1**N as the output of transmitter **320**.

Receive equalizer **325** supports two post-cursor filter taps in this embodiment, though more or fewer may be used in other embodiments. Equalizer **325** is a decision-feedback equalizer (DFE) in this example, though other types of equalizers may be used instead of or in addition to a DFE. For example, equalizer **325** may include one or more partial-response DFE (PrDFE) taps, for example of the type described in published U.S. Patent App. No. 20050111585 to Stojanovic et al. entitled "Partial Response Receiver." A buffer **345** presents first post-tap data RD_{N-1} (first post cursor) and second post-tap data (second post cursor) data RD_{N-2} to respective coefficient multipliers **346**. Multipliers **346** multiply the outputs of buffer **345** by respective tap coefficients RXα[2,1], and the sum of the outputs of multipliers **346** is subtracted from the incoming signal at pad or pads RxN**1** to produce an equalized signal Veq. Alternatively, receive equalizer **325** could be implemented as a direct continuous-time, linear equalizer with tunable coefficients. In general, an equalizer can adjust the SIR at a particular node in the receiver to achieve some desired characteristic, e.g. a low bit-error rate or, as in the case of a PrDFE, can speculatively apply multiple ISI corrections and later select the appropriate correction to achieve the desired characteristic.

An amplifier **350** within signal monitor **335** compares signal Veq with a selected data level Dlev, outputting a signal indicative of a logic one (zero) if Veq is greater than (less than) level Dlev. A sampler **355** periodically captures the output from amplifier **350** on rising edges of a receive clock signal RClk to produce a series of error samples Err_N. Error samples Err_N are conveyed to equalizer control circuitry **340** as measures of signal ISI for equalized signal Veq.

Amplifier **156** compares signal Veq with reference voltage Vr (e.g. zero volts), outputting a signal indicative of a logic one (zero) if Veq is greater than (less than) level Vr. Sampler **158** periodically captures the output from amplifier **156** on rising edges of receive clock signal RClk to produce a series of data samples $Data_N$. Data samples $Data_N$ are conveyed to equalizer control circuitry **340** and to any other circuitry (not shown) to which the received data RxD**1** is directed. In accordance with the depicted embodiment, control circuitry **340** employs the data and error samples to derive data level Dlev, transmit equalization coefficients TXα[1,0,−1] for transmitter **320**, and receive equalization coefficients RXα[2,1] for receive equalizer **325**.

FIG. **4**A depicts equalization control circuitry **340** in accordance with one embodiment. Control circuitry **340** includes a tap controller **400**, a data filter **405**, transmit calibration block **410**, a transmit-coefficient generator **415**, and a DAC **417**. Tap controller **400** includes a series of synchronous storage elements **420** and tap-value generators **425** that together generate, from data and error samples $Data_N$ and Err_N, tap coefficients RXα[2,1,0]. Tap value RXα[0] is a digital measure of the average amplitude of the received data symbols $Data_{N-1}$, which DAC **417** converts into voltage Dlev. Tap values RXα[2,1] are the receive coefficients for equalizer **325**.

The error comparisons that produce error signals Err_N are based upon the upper signal level defined by voltage Dlev and applied via amplifier **350**. Tap controller **400** thus only updates the tap values RXα[2,1,0] based upon measurements that take place when the data sample $Data_{N-1}$ is a logic one. Data filter **405** therefore prevents updates to tap controller

400 when the sample $Data_{N-1}$ is a logic zero. Other embodiments can include a second comparator/sampler pair to generate error samples when $Data_{N-1}$ is a logic zero, such as by comparing the incoming signal Veq with the lower data level −Dlev, or the reference voltage to comparator **350** can be varied over a number of values or ranges of values to facilitate additional testing and error-correction methods.

Receive coefficients RXα[2,1,0] are adjusted to account for the transfer characteristics of receive channel **125**. The calibrated receive coefficients RXα[2,1,0] are therefore measures of the transfer function for channel **125**. Assuming transmit channel **120** and receive channel **125** exhibit similar transfer characteristics, receive coefficients RXα[2,1,0] are also a measure of the transfer characteristics of transmit channel **120**. Devices in accordance with some embodiments use receive coefficients to derive suitable transmit coefficients. In the embodiment of FIG. **4**A, this derivation additionally takes into account a pre-cursor receive coefficient RXα[−1] produced by calibration block **410** but not used for receive-side equalization in this example. Coefficient generator **415** may then derive transmit coefficients from receive coefficients e.g. in a manner detailed below.

FIG. **4**B details an embodiment of a tap-value generator **425** of FIG. **4**A that generates a tap value using a sign-sign, least-mean-squared (LMS) algorithm. Other algorithms, such as linear or gradient-descent LMS, can be used in other embodiments. Generator **425** includes an XNOR gate **430**, a multiplier **435** that multiplies the output of XNOR gate **430** by a constant μ, an adder **440**, and a register **445**. XNOR gate **430** compares the corresponding data and error samples and presents its output to multiplier **435**. The output of XNOR gate **430** represents a logic one for true and a logic negative one for false. The data and error samples represent the signs of the sampled values, so XNOR gate **430** has the effect of multiplying the signs and presenting the resulting product to multiplier **435**. Multiplier **435** multiplies the product from XNOR gate **430** by a selected step size μ, which may be tailored for the selected filter tap. Adder **440** adds the output from multiplier **435** to the current contents of register **445**, which is then updated with the new count. Register **445** thus accumulates a count representative of the alpha value for the filter tap associated with the data samples of a particular latency.

FIGS. **5**A through **5**D are hypothetical waveform diagrams used in connection with FIGS. **3** and **4**A to illustrate the process of applying appropriate receive coefficients RXα[2,1] to DFE **325** to correct for ISI introduced over channel **125**. FIG. **5**A depicts an idealized transmit pulse **500** for which the value expressing the current data sample D_N at transmitter pad Tx**2**N is normalized to a value of one (1.0) and the prior and subsequent data samples D_{N-1} and D_{N+1} are each normalized to a value of zero (0.0). FIG. **5**B depicts, as a waveform **505**, a version of transmit pulse **500** filtered by receive channel **125** and appearing at pad Rx**1**N. As compared with pulse **500**, pulse **505** is attenuated to a maximum amplitude of 0.5 for the current data sample D_N, the corrupted version of which is labeled cD_N. The pulse is further corrupted by channel ISI, which leads to erroneous positive signal amplitudes of approximately cD_{N+1}=0.12 and cD_{N+2}=0.02 at the two succeeding symbol times, and cD_{N-1}=0.05 at the preceding symbol time. The objective of receive equalization is, in part, to compensate for the ISI effects at the symbol times succeeding the main symbol time.

FIG. **5**C is a waveform diagram **510** in which a receive-coefficient waveform **515** is shown with the shape of pulse **505** of FIG. **5**B to illustrate how the receive coefficients are applied to compensate for ISI imposed by channel **125**. In the example, the channel **125** imposed ISI components cD_{N+1} and cD_{N+2} of respective amplitudes 0.12 and 0.02 at the two symbol times succeeding reception of corrupted data symbol cD_N. DFE **325** therefore subtracts a coefficient waveform **515** from the received pulse **505** to cancel the ISI: DFE **325** subtracts $Data_N$*RXα[1] from the received signal one symbol time after cD_N and subtracts $Data_N$*RXα[2] from the received signal two symbol times after cD_N. In this example, RXα[0] is about 0.50, RXα[1] about 0.12, and RXα[2] about 0.02.

FIG. **5**D depicts an equalized waveform **520** that is the sum of waveforms **505** and **515** of FIG. **5**C. Ideally, the compensation provided by DFE **325** exactly counteracts the ISI associated with the prior data symbols without adversely impacting the current symbol. In practice, however, the application of receive coefficients may impact the current symbol eD_N. Furthermore, ISI associated with the first pre-cursor tap is not cancelled in this example, and therefore leaves a noise artifact cD_{N-1} in waveform **520** one symbol time prior to receipt of the current symbol. The two post-tap artifacts are cancelled in this example, however, leaving equalized signal values eD_{N+1} and eD_{N+2} of amplitude zero.

Returning to FIG. **4**A, coefficient generator **415** employs receive coefficients RXα[1,0,−1] to calculate transmit coefficients TXα[1,0,−1]. In the description thus far, however, tap controller **400** has calculated only two of the three receive coefficients employed by coefficient generator **415**. The following discussion shows how equalization control circuitry **340** of FIG. **3** can calculate a pre-cursor receive-channel coefficient RXα[−1] in accordance with one embodiment.

FIG. **6** is a flowchart **600** outlining a process by which calibration block **410** may calculate pre-cursor receive-channel coefficient RXα[−1]. First, in step **605**, the receive coefficients RXα[2,1,0] are calculated in the manner detailed above. In some embodiments, step **605** is accomplished by first holding values RXα[2,1] constant until value RXα[0] reaches equilibrium, at which time voltage Dlev represents a measure of the average symbol amplitude for signal Veq. With reference to FIG. **3**, voltage Dlev is considered to represent the amplitude of signal Veq when error signal Err_{N-1} is equally likely to express a logic one or a logic zero when the corresponding sampled data symbol $Data_{N-1}$ represents a logic one. Once voltage Dlev is established, the other two tap-value generators are enabled to find the remaining receive coefficients RXα[2,1]. Once calibrated, the values of receive coefficients RXα[2,1] are held constant (step **607**).

Next, in step **610**, data filter **405** is set to enable Dlev adjustment when incoming data expresses the pattern "10" (i.e., symbol $Data_{N-1}$=1 and succeeding symbol $Data_N$=0). Per decision **615** and step **620**, error samples Err_{N-1} are collected and coefficient RXα[0] adjusted until Err_{N-1} is again 50% 1's and 50% 0's when this pattern is detected. Using the circuitry of FIG. **4**A, these adjustments occur automatically as tap controller **400** finds the coefficient RXα[0], and consequently the level Dlev, specific to "10" data patterns. In step **625**, calibration block **410** then stores the value of coefficient RXα[0] as RXα**10**. The process of steps **610** through **625** is repeated for data pattern "11". That is, in step **630** data filter **405** is set to enable Dlev adjustment when incoming data expresses the pattern "11" (i.e., symbol $Data_{N-1}$=1 and succeeding symbol $Data_N$=1). Per decision **635** and step **640**, error samples Err_{N-1} are collected and coefficient RXα[0], and consequently level Dlev, is adjusted until Err_{N-1} is again 50% 1's and 50% 0's. Calibration block **410** then, in step **645**, stores the new value of RXα[0] as RXα**11**.

With coefficients RXα[2,1] calibrated, the difference between values RXα**11** and RXα**10** can largely be attributed

to two times the ISI associated with the first pre-cursor filter position. Filter coefficient RXα[−1] can therefore be calculated using this difference (step **650**). In some embodiments the difference may be scaled, as by multiplying the difference by a constant C, or may be otherwise adjusted, for example, to compensate for different transmit characteristics between the controller and memory device. Other embodiments employ similar techniques to calculate additional pre- or post-cursor transmit or receiver filter coefficients. Returning to the hypothetical example of FIGS. **5**A through **5**D, it may be seen that corrupted data sample cD_{N-1} has a value of about 0.05, so coefficient RXα[−1] is set to 0.05.

Transmitter **320** of FIG. **3** typically has a maximum output power that is divided among its three taps. For illustrative purposes, that output power may be normalized to a value of one. Coefficient generator **415** (FIG. **4**A) is therefore constrained, in this embodiment, such that the sum of the absolutes values of the three filter coefficients TXα[1,0,−1], which represents the total power output of the transmitter, is equal to one. In equation form:

$$|TX\alpha[1]|+|TX\alpha[0]|+|TX\alpha[-1]|=1 \quad \text{Eq. 2}$$

Assuming similar transmit and receive channels, the following relationships between the transmit and receive coefficients can be used in the embodiment to approximately correct for ISI in channel **120**:

$$TX\alpha[1]/TX\alpha[0]=-RX\alpha[1]/RX\alpha[0] \quad \text{Eq. 3}$$

$$TX\alpha[-1]/TX\alpha[0]=-RX\alpha[-1]/RX\alpha[0] \quad \text{Eq. 4}$$

Combining equations two through four and solving for each transmit coefficient gives:

$$TX\alpha[1]=(-RX\alpha[1]/RX\alpha[0])/(1+|RX\alpha[1]/RX\alpha[0]|+|RX\alpha[-1]/RX\alpha[0]|) \quad \text{Eq. 5}$$

$$TX\alpha[0]=(1+|RX\alpha[1]/RX\alpha[0]|+|RX\alpha[-1]/RX\alpha[0]|)^{-1} \quad \text{Eq. 6}$$

$$TX\alpha[-1]=(-RX\alpha[-1]/RX\alpha[0])/(1+|RX\alpha[1]/RX\alpha[0]|+|RX\alpha[-1]/RX\alpha[0]|) \quad \text{Eq. 7}$$

The transmit coefficients, including one or more pre-emphasis coefficients, can thus be derived using receive coefficients as a measure of transmit-channel characteristics. In the example discussed above in connection with FIGS. **5**A-**5**D, the hypothetical receive coefficients RXα[1,0,−1] were about 0.12, 0.5, and 0.05, respectively. Applying these results to equations five through seven gives approximately: TXα[1]=−0.18, TXα[0]=0.75, and TXα[−1]=−0.07.

A more comprehensive solution if RXα[−2] and RXα[2] are measured (using a similar method to that in FIG. **6**) is to solve the following matrix equation for TXα[1], TXα[0], and TXα[−1]:

$$[0\ \ 1\ \ 0] = [TX\alpha[-1]TX\alpha[0]TX\alpha[1]] \cdot \begin{bmatrix} RX\alpha[0], RX\alpha[1], RX\alpha[2] \\ RX\alpha[-1], RX\alpha[0], RX\alpha[1] \\ RX\alpha[-2], RX\alpha[-1], RX\alpha[0] \end{bmatrix} \quad \text{Eq. 8}$$

This solution must then be normalized to a total amplitude of one by dividing the solution by |TXα[1]|+|TXα[0]|+|TXα[−1]|. This techniques can be used generally for any number of taps on the transmitter equalizer or receive DFE. For example, the matrix of equation 8 may be extended and solved for cases where additional ISI components are measured and additional TX FIR taps are available. In an alternate embodiment, a simple mapping table, which can be realized through a table-lookup ROM, RAM, or through firmware, can provide the means to set TX equalizer coefficients from RX equalizer coefficients.

FIGS. **7**A through **7**C are hypothetical waveform diagrams used to illustrate the effects of applying the above-derived transmit coefficients to signals on transmit channel **120**. FIG. **7**A depicts an idealized transmit pulse **700** for which the value expressing the current data sample D_N at transmitter pad Tx**1**N is normalized to a value of one (1.0) and the respective prior and subsequent data samples D_{N-1} and D_{N+1} are normalized to values of zero (0.0). As noted previously, transmit channel **120** is presumed to be similar to receive channel **125** for which receive coefficients RXα[1,0,−1] were derived. This is important, as the expected similarity of the transfer characteristics between the receive and transmit channels supports the assumption that transmit equalizer coefficients can be derived from the receive equalizer coefficients and/or ISI measurements. Based upon this assumption, the channel filtered version of pulse **700**, as it appears at pad Rx**2**N, is expected to be relatively similar to pulse **505** of FIG. **5**B, and has been illustrated accordingly in FIG. **7**B. In other words, assuming the same normalized transmit pulse from transmitters Tx**1** and Tx**2**, receiver pad Rx**2**N will see a pulse response with substantially the same ISI as would be seen at receiver pad Rx**1**N. In the example of FIG. **5**B, the receive channel **125** of lane **115** attenuated symbol D_N by half, resulting in a corrupted symbol cD_N. The receive channel additionally imposed ISI components cD_{N+2}=0.02, cD_{N+1}=0.12, and cD_{N-1}=0.05, so pulse **705** of FIG. **7**B is assumed to have the same ISI components.

FIG. **7**C is a waveform diagram **710** in which a pulse waveform **715** is shaped by application of the transmit coefficients calculated by applying receive coefficients RXα[1, 0,−1] to equations two through seven: TXα[1]=−0.18, TXα[0]=0.75, and TXα[−1]=−0.07. Waveform **715** is pre-emphasized using these tap values to produce a transmit-equalized pulse in which the combined output power of pre-emphasized values pD_{N-1}, pD_N, and pD_{N+1} is one. Ideally, the pre-emphasis provided by the transmit equalizer exactly counteracts the ISI induced by channel **120** without adversely impacting the current symbol.

FIG. **7**D is a waveform diagram **720** depicting a pulse **725** at pad Rx**2**N. Pulse **725** is the shape of the pulse received at Rx**2**N when waveform **715** of FIG. **7**C is transmitted from Tx**1**N and subsequently filtered by channel **120**. The current received value of symbol rD_N is attenuated to about 0.35, while the pre- and post-tap values rD_{N-1} and rD_{N+1} are reduced to approximately zero. Transmitter **320** does not compensate for post-tap corruption at time N+2, so pulse **725** exhibits a non-zero artifact rD_{N+2}. Convolution of the transmitted waveform in FIG. **7**C with the response of the channel also results in small non-zero artifacts rD_{N-2} and rD_{N+3}.

FIG. **8** depicts a system **800** in accordance with another embodiment. System **800** includes a first IC **805** coupled to a second IC **810** via a bidirectional communication channel **815**. IC **805** includes transmitter **820** with an M tap FIR equalizer that communicates transmit signals TxD**1** to a corresponding receiver **825** on IC **810**. Receiver **825** on IC **810** includes from zero to R receive DFE taps, where R is less than X. IC **805** additionally includes receiver **830** with an X-tap DFE that receives pre-emphasized transmissions of signals TxD**2** from a corresponding transmitter **835** on IC **810**. Transmitter **835** on IC **810** includes from zero to Y transmitter FIR taps, where Y is less than M. In some embodiments, each of M and X is greater than the number of taps in either receiver **825**

or transmitter **835**. Transmit coefficients TxCo can be derived from characteristics of the receive signal, e.g. in the manner described above.

The complete channel transfer function from IC **805** to IC **810**, which includes characteristics of transmitter **820** and receiver **825** (e.g. gain, bandwidth, and edge-rate) may not precisely match the complete channel transfer function in the opposite direction. This may be true even in the case where the channel wire is identical in both directions. The coefficient mapping between receiver **830** and transmitter **820** can be altered to accommodate such differences, however. For example, if transmitter **835** has a known, fixed transfer function, that transfer function can be de-convolved from the transmit filter settings for transmitter **820** using e.g. equation 8. Similarly, if receiver equalizer **825** has a known transfer function, it too can be de-convolved from the transmit filter settings. Adjustments can then be made to the coefficient mapping between receiver **830** and transmitter **820** via table-lookup or other methods.

FIG. **9** depicts a system **900** in accordance with yet another embodiment. System **900** is similar to system **800** of FIG. **8**, like-numbered elements being the same or similar. In system **900**, however, IC **805** communicates with a plurality of IC devices **810** via a multi-drop bus **905**. FIG. **9** illustrates an additional benefit of embodiments in which relatively complex transmit and receive circuitry are instantiated on one end of a signal lane. In the depicted example, one complex transmitter and one complex receiver are instantiated on IC **805** so that each instance of IC **810** can be implemented using a relatively simpler receiver/transmitter pair. Complexity of one IC can therefore be used to simplify a plurality of other ICs. As in the example of FIG. **8**, transmit coefficients TxCo can be derived from characteristics of the receive signal.

FIG. **10** depicts four memory topologies **1000**, **1005**, **1010**, and **1012** that incorporate asymmetrical signaling systems in accordance with some of many possible embodiments. Topology **1000** includes a memory controller **1015**, a memory buffer **1020**, and a number N of memory ICs **1025**[N:1]. Memory buffer **1020** includes transmit and receive circuitry **1030** that is relatively complex as compared with the corresponding transceiver circuitry on memory ICs **1025**[N:1]. The system of topology **1000** can thus support relatively high symbol rates without burdening memory ICs **1025**[N:1] with the area and power required to support complex equalization circuits.

Topology **1005** is similar to topology **1000**, like-numbered elements being the same or similar. In topology **1005**, a memory buffer **1035** includes two sets of transmit and receive circuitry **1030**: one to communicate with memory controller **1015** and another to communicate with memory ICs **1025**[N:1]. The system of topology **1000** can thus support relatively high symbol rates without burdening memory ICs **1025**[N:1] or memory controller **1015** with the area and power required to support complex equalization circuits.

Topology **1010** includes a memory controller **1040**, an optional memory buffer **1045**, and a number N of memory ICs **1050**[N:1]. Memory controller **1040** includes transmit and receive circuitry **1055** that is relatively complex as compared with the corresponding transceiver circuitry on buffer **1045** and/or memory ICs **1050**[N:1]. The system of topology **1010** can thus support relatively high symbol rates without burdening buffer **1045** and/or memory ICs **1050**[N:1] with the area and power required to support complex equalization circuits.

Topology **1012** includes a memory controller **1056**, two or more memory buffers **1060**, and a number of memory ICs **1065** for each buffer **1060**. Each memory buffer **1060** includes transmit and receive circuitry **1030** to communicate with memory controller **1055**. In other embodiments memory buffer **1060** may communicate with memory ICs **1065** via transmit and receive circuitry that is the same or similar to circuitry **1030**.

It can be observed that in any of these embodiments which include multiple memory devices connected to a single TX/RX block that multiple coefficients may be stored and used for equalization. Each of the multiple coefficients may be tailored for the individual channels between the controller and each memory device. These coefficients can be stored in a memory, a register file or using other means. The coefficients may then be selected for use based on the memory device with which the controller is communicating.

In the foregoing description and in the accompanying drawings, specific terminology and drawing symbols are set forth to provide a thorough understanding of the present invention. In some instances, the terminology and symbols may imply specific details that are not required to practice the invention. For example, the interconnection between circuit elements or circuit blocks may be shown or described as multi-conductor or single conductor signal lines. Each of the multi-conductor signal lines may alternatively be single-conductor signal lines, and each of the single-conductor signal lines may alternatively be multi-conductor signal lines. Signals and signaling paths shown or described may be single-ended or differential, and embodiments of the invention may be adapted for use with binary or multilevel-pulse-amplitude-modulated (multi-PAM) signals.

An output of a process for designing an integrated circuit, or a portion of an integrated circuit, comprising one or more of the circuits described herein may be a computer-readable medium such as, for example, a magnetic tape or an optical or magnetic disk. The computer-readable medium may be encoded with data structures or other information describing circuitry that may be physically instantiated as an integrated circuit or portion of an integrated circuit. Although various formats may be used for such encoding, these data structures are commonly written in Caltech Intermediate Format (CIF), Calma GDS II Stream Format (GDSII), or Electronic Design Interchange Format (EDIF). Those of skill in the art of integrated circuit design can develop such data structures from schematic diagrams of the type detailed above and the corresponding descriptions and encode the data structures on computer readable medium. Those of skill in the art of integrated circuit fabrication can use such encoded data to fabricate integrated circuits comprising one or more of the circuits described herein.

While the present invention has been described in connection with specific embodiments, the invention should not be so limited. For example,

1. Receivers in accordance with the invention can incorporate a variable-gain amplifier to provide DC-offset or automatic-gain control. Such amplifiers can be configurable or can be controlled e.g. using Dlev to establish and maintain desired DC signal levels.
2. Transmitters in accordance with the invention can likewise incorporate a pre-distorted offset to provide compensation for any receiver DC-offset or automatic-gain control. Such transmitter pre-distortion can be configurable or can be controlled e.g. using Dlev mapped and scaled as appropriate for the transmitter.
3. Transmitters and receivers could use test or training patterns in lieu of live data to calibrate transmit and receive coefficients.

4. Other types of equalizers, such as passive or active continuous time analog filters or transversal filters, could be used instead of or in addition to the above-described equalizers.

5. It may be the case that other circumstances drive the desire to put equalization on one device. Cost, complexity, experience, and desire to use standard devices on one end could each be reasons to asymmetrically distribute the equalization burden.

Moreover, some components are shown directly connected to one another while others are shown connected via intermediate components. In each instance the method of interconnection, or "coupling," establishes some desired electrical communication between two or more circuit nodes, or terminals. Such coupling may often be accomplished using a number of circuit configurations, as will be understood by those of skill in the art. Therefore, the spirit and scope of the appended claims should not be limited to the foregoing description. Only those claims specifically reciting "means for" or "step for" should be construed in the manner required under the sixth paragraph of 35 U.S.C. §112.

What is claimed is:

1. A first integrated circuit to communicate with a second integrated circuit over at least one conductive path, the first integrated circuit comprising:

a transmitter to transmit information from the first integrated circuit to the second integrated circuit over a first conductive path, the transmitter including a transmit equalizer;

a receiver to receive information from the second integrated circuit over one of the first conductive path, or a second conductive path; and

a circuit to generate equalization settings for the transmit equalizer responsive to inter-symbol interference affecting the transmission of the information transmitted to the first integrated circuit from the second integrated circuit.

2. The first integrated circuit of claim **1**, where the second integrated circuit comprises a memory device, and where:

the first integrated circuit is embodied as a memory controller integrated circuit;

the transmitter is to transmit the information from the memory controller integrated circuit to the memory device; and

the receiver is to receive information at the memory controller integrated circuit from the memory device.

3. The first integrated circuit of claim **2**, where the information transmitted from the memory controller integrated circuit to the memory device is to exhibit deemphasized low frequency signal components relative to the information to be received by the receiver.

4. The first integrated circuit of claim **3**, where the transmit equalizer includes a pre-cursor tap to apply equalization dependent upon a to-be-transmitted bit of information.

5. The first integrated circuit of claim **2**, where the memory controller integrated circuit further comprises a receive equalizer to provide equalization to information received from the memory device substantially matching the equalization applied to the information transmitted from the memory controller integrated circuit to the memory device.

6. The first integrated circuit of claim **2**, where:

the first conductive path is a bidirectional signaling link;

the receiver is to receive the information from the memory device over the first conductive path; and

the memory controller integrated circuit further comprises a receive equalizer to provide equalization to the information received from the memory device over the first conductive path, where the equalization to be provided by the receive equalizer substantially matches the equalization to be provided to the information transmitted from the memory controller integrated circuit to the memory device.

7. The first integrated circuit of claim **6**, where the equalization to be provided by each of the transmit equalizer and the receive equalizer is to compensate for frequency-dependent channel loss associated with physical characteristics of the bidirectional signaling link.

8. The first integrated circuit of claim **7**, where the receive equalizer includes a continuous-time equalizer.

9. The first integrated circuit of claim **1**, where the receiver includes a data level sampler and a data filter, the equalization settings to be generated based on an output of the data level sampler when the information received by the receiver from the second integrated circuit matches a pattern determined by the data filter.

10. The first integrated circuit of claim **1**, where the first integrated circuit further comprises a receive equalizer to equalize information received by the receiver from the second integrated circuit.

11. The first integrated circuit of claim **10**, where the receive equalizer includes a continuous-time equalizer.

12. The first integrated circuit of claim **10**, where the receive equalizer includes a partial response decision feedback equalizer.

13. The first integrated circuit of claim **10**, where the circuit to generate equalization settings is to generate receive equalization setting for the receive equalizer and is further to use a mapping table to generate transmit equalization settings from the receive equalization settings.

14. The first integrated circuit of claim **1**, where:

the receiver is to receive information from the second integrated circuit over a second conductive path; and

the transmit equalizer is to apply equalization based on measured characteristics of the information received over the second conductive path to the information transmitted by the first integrated circuit over the first conductive path.

15. A memory controller integrated circuit, comprising:

a transmitter to transmit write data from the memory controller integrated circuit to a memory device over a first conductive path, the transmitter including a transmit equalizer;

a receiver to receive data from the memory device over one of the first conductive path, or a second conductive path; and

means for generating transmit equalization settings responsive to inter-symbol interference affecting the transmission of data to the memory controller integrated circuit from the memory device.

16. A memory controller integrated circuit to communicate with a memory device over at least one conductive path, comprising:

a transmitter to transmit information from the memory controller integrated circuit over a first conductive path, the transmitter including a transmit equalizer;

a receiver to receive information from the memory device over one of the first conductive path, or a second conductive path, the receiver including a receive equalizer; and

a circuit to generate settings for the receive equalizer and settings for the transmit equalizer based on measurement of signal parameters associated with the information transmitted to the memory controller integrated circuit from the memory device.

17. The memory controller integrated circuit of claim 16, where the information transmitted from the memory controller integrated circuit to the memory device is to exhibit deemphasized low frequency signal components relative to the information to be received by the receiver.

18. The memory controller integrated circuit of claim 17, where the transmit equalizer includes a pre-cursor tap to apply equalization dependent upon a to-be-transmitted bit of information.

19. The memory controller integrated circuit of claim 18, where the circuit to generate settings is to generate receive equalization setting for the receive equalizer and is further to use a mapping table to generate transmit equalization settings from the receive equalization settings.

20. The memory controller integrated circuit of claim 16, where the transmitter and the receiver each communicate with the memory device using the first conductive path and where equalization applied by each of the transmit equalizer and the receive equalizer is to compensate for frequency-dependent channel loss associated with physical characteristics of the first conductive path.

21. The memory controller integrated circuit of claim 16, where the receive equalizer includes a continuous-time equalizer.

22. The memory controller integrated circuit of claim 16, where the receiver includes a data level sampler and a data filter, the equalization settings to be generated based on an output of the data level sampler when the information received by the receiver matches a pattern determined by the data filter.

23. The memory controller integrated circuit of claim 16, where:

the receiver is to receive information from the device over a second conductive path; and

the transmit equalizer is to apply equalization based on measured characteristics for the second conductive path to the information transmitted by the memory controller integrated circuit over the first conductive path.

24. A memory controller integrated circuit to communicate with a memory device over at least one conductive path, comprising:

a transmitter to transmit information from the memory controller integrated circuit over a first conductive path, the transmitter including a transmit equalizer;

a receiver to receive information from the memory device over one of the first conductive path, or a second conductive path, the receiver including a receive equalizer; and

a circuit to generate equalization settings based on measurements of information transmitted to the memory controller integrated circuit from the memory device;

where the memory controller integrated circuit is to apply at least some of the settings to the receive equalizer to adjust receive equalization and at least some of the settings to the transmit equalizer to adjust transmit equalization.

25. The memory controller integrated circuit of claim 24, where:

the first conductive path is a bidirectional signaling link and the receiver is to receive information from the memory device over the bidirectional signaling link; and

the equalization applied by each of the transmit equalizer and the receive equalizer is to compensate for frequency-dependent channel loss associated with physical characteristics of the first conductive path.

26. The memory controller integrated circuit of claim 24, where:

the receiver is to receive information from the device over a second conductive path; and

the transmit equalizer is to apply equalization based on measured characteristics for the second conductive path to the information transmitted by the memory controller integrated circuit over the first conductive path.

27. The memory controller integrated circuit of claim 26, where the receive equalizer includes a continuous-time equalizer.

28. The memory controller integrated circuit of claim 26, where the transmit equalizer includes a pre-cursor tap to apply equalization dependent upon a to-be-transmitted bit of information.

29. A method of operation in a signaling system in which a memory controller is to communicate with a memory device using at least one conductive path, the memory controller having a transmitter to transmit data to the memory device and a receiver to receive data from the memory device, and a transmit equalizer to equalize the data transmitted by the transmitter, the method comprising:

receiving the data from the memory device using the receiver;

measuring at least one signal parameter representing the data as received from the memory device at the receiver;

adjusting a setting of the transmit equalizer responsive to the at least one signal parameter.

30. The method of claim 29, where the at least one conductive path is bidirectional and the transmitter and receiver each exchange respective data with the memory device over a common bidirectional path, and where method further comprises adjusting settings of each of the transmit equalizer and a receive equalizer, respectively, responsive to the at least one signal parameter.

31. The method of claim 29, where the transmitter is to communicate with the memory device over a first conductive path and the receiver is to communicate with the memory device over a second conductive path, and adjusting the setting includes adjusting a setting for data transmitted by the memory controller over the first conductive path based upon measured characteristics of data transmitted over the second conductive path.

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